

LP SERIES

Low Profile Applicators

Valco Melton's LP Series is the optimal solution for hot melt adhesive application in box sealing processes. Specifically engineered to work in the most demanding packaging lines, its low profile design allows for installation in constricted or limited spaces. The LP Series can be configured to work with standard or orientable modules and permits the use of a wide range of nozzles to cover all kinds of application requirements at the highest quality.

- Low profile design for minimal installation space requirements
- Multiple configuration options to cover all application needs
- 100% compatible with market standards



2 or 4 module option is suitable for any packaging line



Includes mounting bracket to facilitate installation and to increase operating safety avoiding over-heating

> Reduced profile specially designed for box sealing applications



100% compatible connectors



Valco Meltonoffers a complete selection of hot melt components and support equipment:

- RTD hot melt hoses
- · Manual and automatic dispensing valves
- Nozzle and applicator styles
- Mounting bracket packages
- Solid-state pattern control systems
- In-line filters
- Replacement parts for competitive systems
- High-performance hot melt adhesives



Technical Specifications

Specifications	
Max. Operating Temperature	240°C / 464°F
Max. Operating Hydraulic Pressure	100 bar / 1450 psi
Max. Operating Cycle Rate	2400 cycles per minute
Air Pressure	4-6 bar / 58-87 psi
Electrical Supply	190-250 VAC 50/60 Hz



VALCO MELTON
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